

RXPD-10GBD40-2733/RXPD-10GBD40-3327

10Gb/s 40km BiDi XFP Transceiver Hot Pluggable, Single LC, +3.3V, 1270nm/1330nm CWDM DFB, DDM

Features:

- ♦ Supports 9.95Gb/s to 11.3Gb/s bit rates
- ♦ Compliant with IEEE 802.3ae
- \diamond Module A:TX1270/RX1330 \pm 1nm
- ♦ Module B:TX1330/RX1270 ± 1nm
- ♦ Hot-pluggable XFP footprint
- ♦ 1 core, Single LC connector for Bi-directional Transmission
- ♦ Maximum link length of 40km
- ♦ Built-in 1270/1330 WDM
- ♦ Uncooled 1270nm or 1330nm CWDM DFB Laser.
- ♦ Power dissipation <2W</p>
- ♦ No Reference Clock required
- ♦ Built-in digital diagnostic functions
- → Temperature range 0°C to 70°C
- ♦ Very low EMI and excellent ESD protection
- ♦ RoHS Compliant Part
- → Fully Metallic Enclosure for low EMI

Applications:

- ♦ 10GBASE-LR/LW Ethernet
- ♦ SONET OC-192 /SDH
- ♦ 1200-SM-LL-L 10G Fibre Channel

Description:

RXPD-10GBD40-2733/3327 Bi-directional 10Gb/s (XFP) transceivers are compliant with the current XFP Multi-Source Agreement (MSA) Specification. They comply with 10-Gigabit Ethernet 10GBASE-LR/LW per IEEE 802.3ae, SONET OC-192 /SDH and 10G Fibre Channel 1200-SM-LL-L. Digital diagnostics functions are available via a 2-wire serial interface, as specified in the XFP MSA.

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Storage Temperature	T _{ST}	-40	+85	$^{\circ}\mathrm{C}$
Case Operating Temperature	T _{IP}	0	+70	°C
Supply Voltage	V _{CC3}	-0.5	+4.0	V

Electrical Characteristics (T_{OP} = 0 to 70 °C)

Parameter	Symbol	Min	Тур	Max	Unit	Note			
Supply Voltage	Vcc3	3.13	3.3	3.45	V				
Supply Current	Icc3			500	mA				
Module total power	Р			2	W				
Transmitter									
Input differential impedance	Rin		100		Ω	1			
Differential data input swing	Vin,pp	150		820	mV				
Transmit Disable Voltage	V_D	2.0		Vcc	V				
Transmit Enable Voltage	V _{EN}	GND		GND+ 0.8	V				
Transmit Disable Assert Time	T_off			100	ms				
Tx Enable Assert Time	T_on			100	ms				
Receiver	Receiver								
Differential data output swing	Vout,pp	300	500	850	mV				
Data output rise time	tr			35	ps	2			
Data output fall time	tf			35	ps	2			
LOS Fault	V _{LOS fault}	Vcc – 0.5		Vcc _{HOST}	V	3			
LOS Normal	V _{LOS norm}	GND		GND+0.5	V	3			
Power Supply Rejection	PSR	See Note 4 below				4			

Notes

- 1. After internal AC coupling.
- 2.20 80 %
- 3.Loss of Signal is open collector to be pulled up with a 4.7k 10kohm resistor to 3.15 3.6V. Logic 0 indicates normal operation; logic 1 indicates no signal detected.
- 4. Per Section 2.7.1. in the XFP MSA Specification.

Optical Parameters(T_{OP} = 0 to 70°C)

P	Symbol	Min	Тур	Max	Unit	Ref.	
Transmitter							
Operating Date	BR	9.95		11.3	Gb/s		
Bit Error Rate		BER			10-12		
Maximum Laune	ch Power	P _{MAX}	0		5	dBm	1
Optical Center	RXPD-10GBD40-2733	3	1260	1270	1280		
Wavelength	RXPD-10GBD40-3327	λ	1320	1330	1340	nm	
Optical Extinction	on Ratio	ER	3.5			dB	
Spectral Width		Δλ			1	nm	
Sidemode Supre	ession ratio	SSRmin	30			dB	
Rise/Fall Time (2	20%~80%)	Tr/Tf			50	ps	
Average Launch	P _{OFF}			-30	dBm		
Transmitter							
Tx Jitter		Txj	Compliant with each standard				
		requirements					
Optical Eye Mas	k		IEEE802.3ae				2
Receiver							
Operating Date Rate		BR	9.95		11.3	Gb/s	
Receiver Sensitivity		Sen			-16	dBm	2
Maximum Input Power		P _{MAX}	0			dBm	2
Optical Center	RXPD-10GBD40-2733	1	1320	1330	1340		
Wavelength	RXPD-10GBD40-3327	λ_{C}	1260	1270	1280	nm	
Receiver Reflect	Rrx			-27	dB		
LOS De-Assert	LOS _D			-15	dBm		
LOS Assert	LOS _A	-30			dBm		
LOS Hysteresis	LOS _H	0.5		5	dB		
Notes						•	

Notes:

- 1. The optical power is launched into SMF.
- 2. Measured with a PRBS 2^{31} -1 test pattern @10.3125Gbps BER<10⁻¹².

Pin Assignment

Diagram of Host Board Connector Block Pin Numbers and Name

GND 1 VEE5 2 3 Mod_Desel Interrupt 4 TX_DIS 5 VCC5 6 GND 7 8 VCC3 VCC3 9 SCL 10 11 SDA Mod_ABS 12 Mod_Nr 13 RX_LOS 14 15 GND

30 GND TD+ 29 TD-28 GND 27 26 GND 25 RefCLK-RefCLK+ 24 23 GND VCC2 22 21 P_Down/RST 20 Vcc2 19 GND RD+ 18 RD-17 16 GND

Bottom of Board (As view through top of board)

Top of Board

Pin Function Definitions

Pin	Logic	Symbol	Name/Description	
1		GND	Module Ground	1
2		VEE5	Optional –5.2 Power Supply – Not required	
3	LVTTL-I	Mod-Desel	Module De-select; When held low allows the module to	
			respond to 2-wire serial interface commands	
4	LVTTL-O	Interrupt	Interrupt (bar); Indicates presence of an important	
			condition which can be read over the serial 2-wire	
			interface	
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off	
6		VCC5	+5 Power Supply	
7		GND	Module Ground	1

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8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTL-I	SCL	Serial 2-wire interface clock	
11	LVTTL- I/O	SDA	Serial 2-wire interface data line	
12	LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2
13	LVTTL-O	Mod_NR	Module Not Ready;	2
14	LVTTL-O	RX_LOS	Receiver Loss of Signal indicator	2
15		GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RD-	Receiver inverted data output	
18	CML-O	RD+	Receiver non-inverted data output	
19		GND	Module Ground	1
20		VCC2	+1.8V Power Supply – Not required	
21	LVTTL-I	P_Down/RS T	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent	
22		VCC2	to a power cycle. +1.8V Power Supply – Not required	
23		GND	Module Ground	1
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board – Not required	3
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host board – Not required	3
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Module Ground	1

Note

- 1. Module circuit ground is isolated from module chassis ground within the module.
- 2. Open collector; should be pulled up with 4.7k 10k ohms on host board to a voltage between 3.15Vand 3.45V.
- 3. A Reference Clock input is not required.

Digital Diagnostic Functions

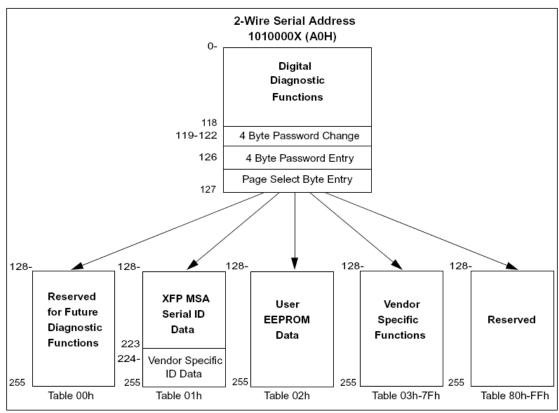
As defined by the XFP MSA 1, FTTX's XFP transceivers provide digital diagnostic functions via a 2-wire serial interface, which allows real-time access to the following operating parameters:

- ✓ Transceiver temperature
- ✓ Laser bias current
- ✓ Transmitted optical power
- ✓ Received optical power
- ✓ Transceiver supply voltage

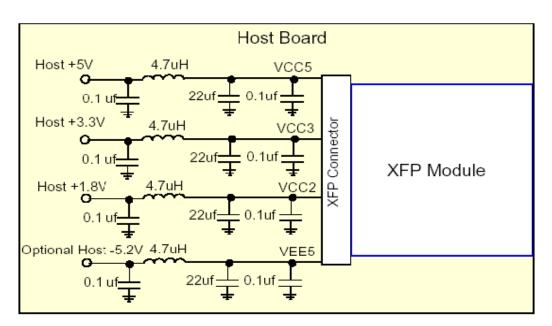
It also provides a sophisticated system of alarm and warning flags, which may be used to alert end-users when particular operating parameters are outside of a factory-set normal range.

The operating and diagnostics information is monitored and reported by a Digital Diagnostics Transceiver Controller (DDTC) inside the transceiver, which is accessed through the 2-wire serial interface. When the serial protocol is activated, the serial clock signal (SCL pin) is generated by the host. The positive edge clocks data into the XFP transceiver into those segments of its memory map that are not write-protected. The negative edge clocks data from the XFP transceiver. The serial data signal (SDA pin) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially. The 2-wire serial interface provides sequential or random access to the 8 bit parameters, addressed from 000h to the maximum address of the memory.

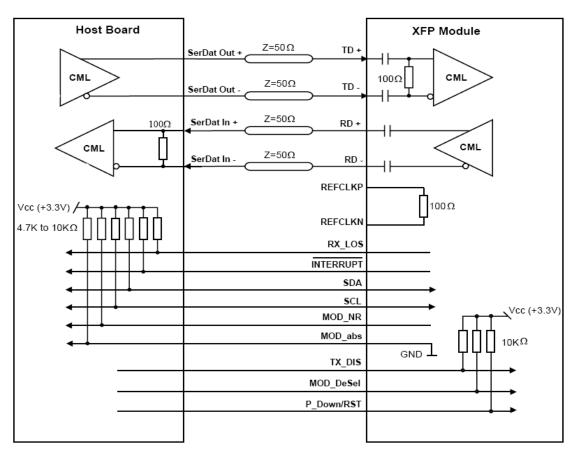
For more detailed information including memory map definitions, please see the XFP MSA Specification.



Recommended Circuit



Recommended Host Board Power Supply Circuit



Recommended High-speed Interface Circuit

Mechanical Dimensions

